Diode

Rapid Switching Emitter Controlled Diode

IDP40E65D2

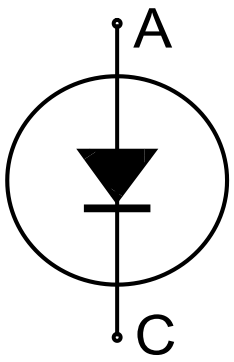
Emitter Controlled Diode

Data sheet

Industrial Power Control

Rapid Switching Emitter Controlled Diode

Features:



- Qualified according to JEDEC for target applications
- 650 V Emitter Controlled technology
- Fast recovery
- Soft switching
- Low reverse recovery charge
- Low forward voltage and stable over temperature
- 175 °C junction operating temperature
- Easy paralleling
- Pb-free lead plating; RoHS compliant

Applications:

- Boost diode in CCM PFC



Key Performance and Package Parameters

Type	V_{rrm}	I_f	V_f, T_{vj}=25°C	T_{vjmax}	Marking	Package
IDP40E65D2	650V	40A	1.6V	175°C	E40ED2	PG-TO220-2-1

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Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	650	V
Diode forward current, limited by T_{vjmax} T_C = 25°C T_C = 100°C	I_F	 80.0 40.0	A
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpuls}	120.0	A
Diode surge non repetitive forward current T_C = 25°C, t_p = 8.3ms, sine halfwave	I_{FSM}	 250.0	A
Power dissipation T_C = 25°C	P_{tot}	200.0	W
Operating junction temperature	T_{vj}	-40...+175	°C
Storage temperature	T_{stg}	-55...+150	°C
Soldering temperature, wave soldering 1.6 mm (0.063 in.) from case for 10s		 260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
Diode thermal resistance,[1)] junction - case	$R_{th(j-c)}$		0.75	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		62	K/W

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Diode forward voltage	V_F	I_F = 40.0A T_{vj} = 25°C T_{vj} = 175°C	 - -	 1.60 1.65	 2.20 -	V
Reverse leakage current	I_R	V_R = 650V T_{vj} = 25°C T_{vj} = 175°C	 - -	 - -	 40.0 4000.0	µA

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristic						
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	7.0	-	nH

[1)] Please be aware that in non standard load conditions, due to high Rth(j-c), Tvj close to Tvjmax can be reached.

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Diode Characteristic, at T_{vj} = 25°C						
Diode reverse recovery time	t_{rr}	T_{vj} = 25°C, V_R = 400V, I_F = 40.0A, di_F/dt = 1000A/µs	-	36	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.40	-	µC
Diode peak reverse recovery current	I_{rrm}		-	22.0	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-10000	-	A/µs
Diode reverse recovery time	t_{rr}	T_{vj} = 25°C, V_R = 400V, I_F = 40.0A, di_F/dt = 200A/µs	-	75	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.13	-	µC
Diode peak reverse recovery current	I_{rrm}		-	2.9	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-54	-	A/µs

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Diode Characteristic, at T_{vj} = 175°C/125°C						
Diode reverse recovery time	t_{rr}	T_{vj} = 175°C, V_R = 400V, I_F = 40.0A, di_F/dt = 1000A/µs	-	60	-	ns
Diode reverse recovery charge	Q_{rr}		-	1.14	-	µC
Diode peak reverse recovery current	I_{rrm}		-	32.0	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-8700	-	A/µs
Diode reverse recovery time	t_{rr}	T_{vj} = 125°C, V_R = 400V, I_F = 40.0A, di_F/dt = 200A/µs	-	83	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.32	-	µC
Diode peak reverse recovery current	I_{rrm}		-	5.6	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-51	-	A/µs

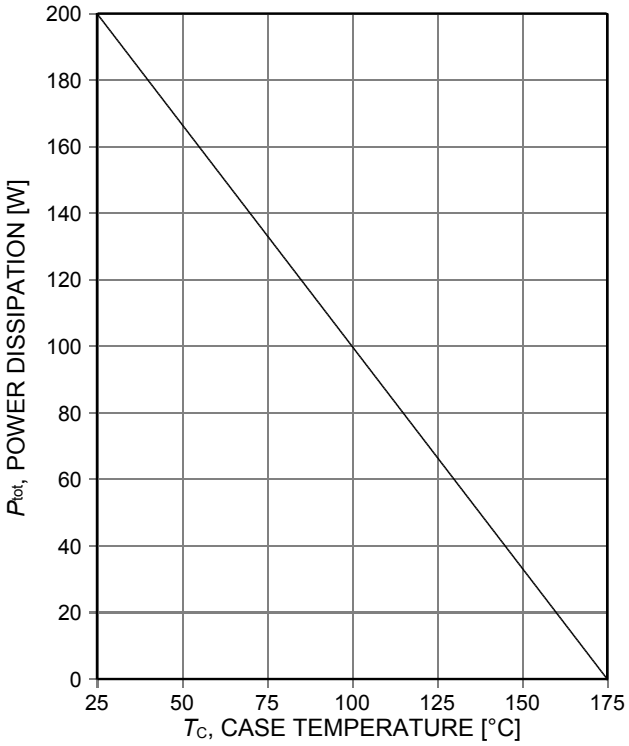


Figure 1. **Power dissipation as a function of case temperature**
(T_{vj}≤175°C)

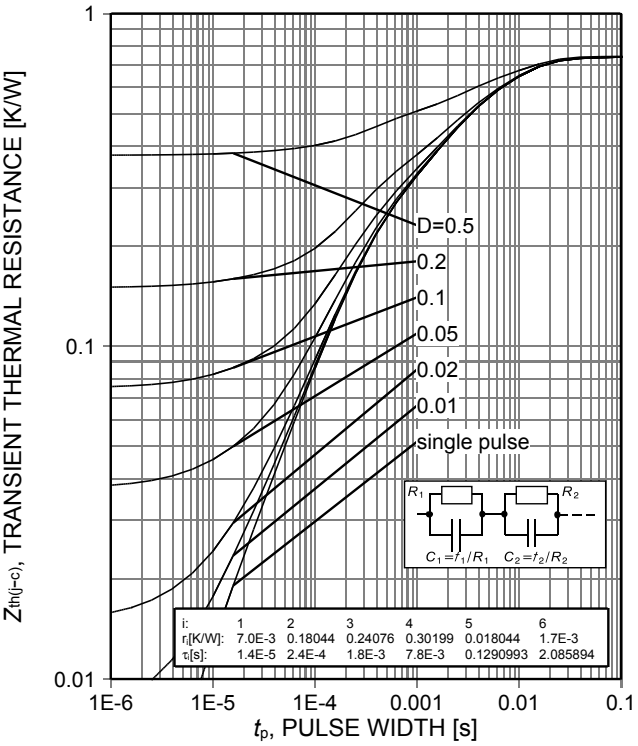


Figure 2. **Diode transient thermal impedance as a function of pulse width**
(D=t_p/T)

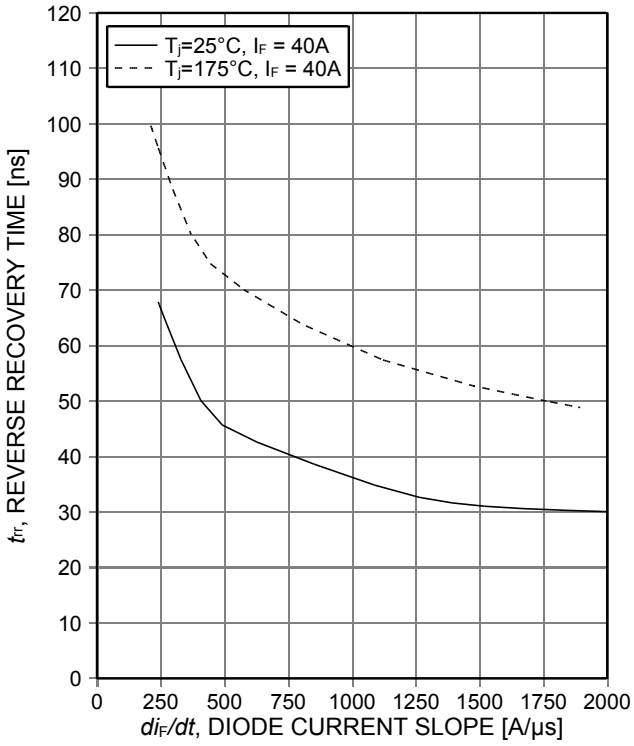


Figure 3. **Typical reverse recovery time as a function of diode current slope**
(V_R=400V)

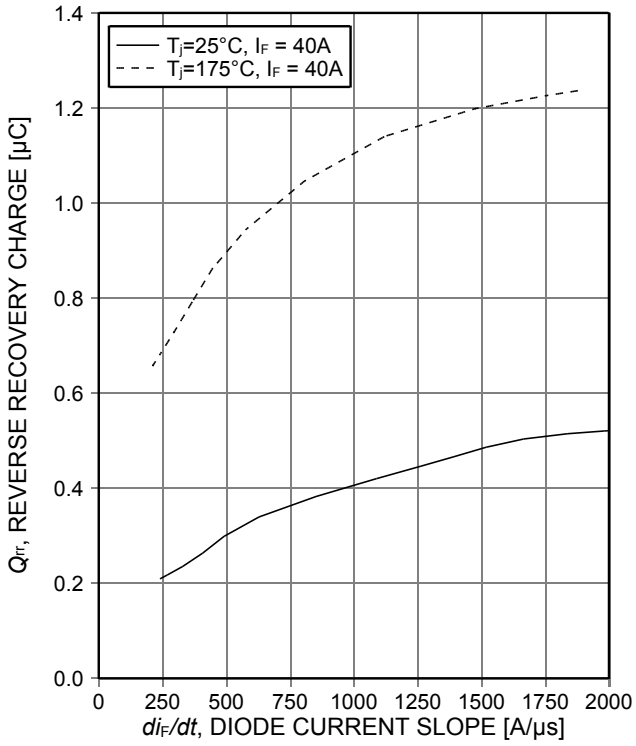


Figure 4. **Typical reverse recovery charge as a function of diode current slope**
(V_R=400V)

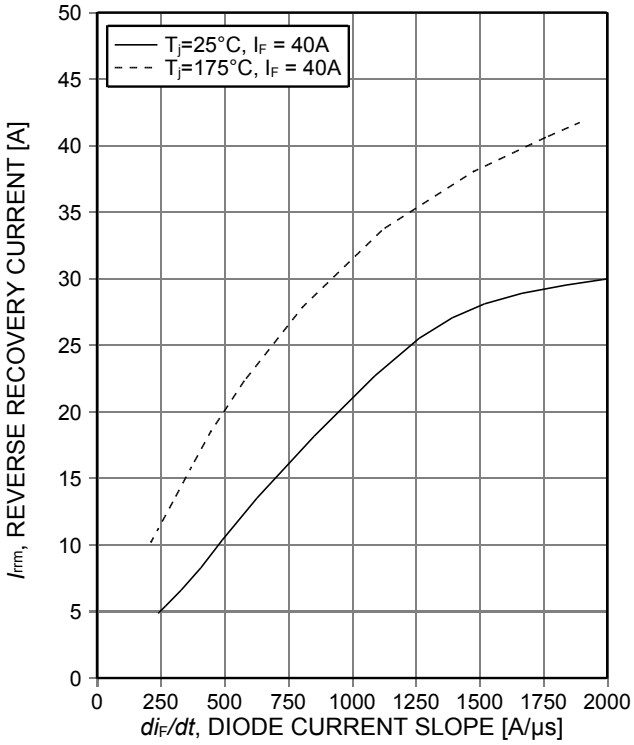


Figure 5. **Typical peak reverse recovery current as a function of diode current slope**
(V_R=400V)

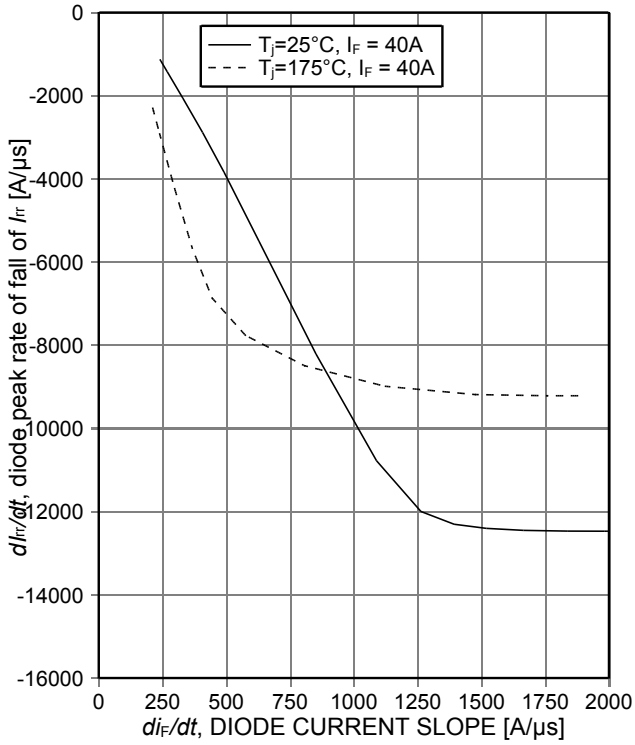


Figure 6. **Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**
(V_R=400V)

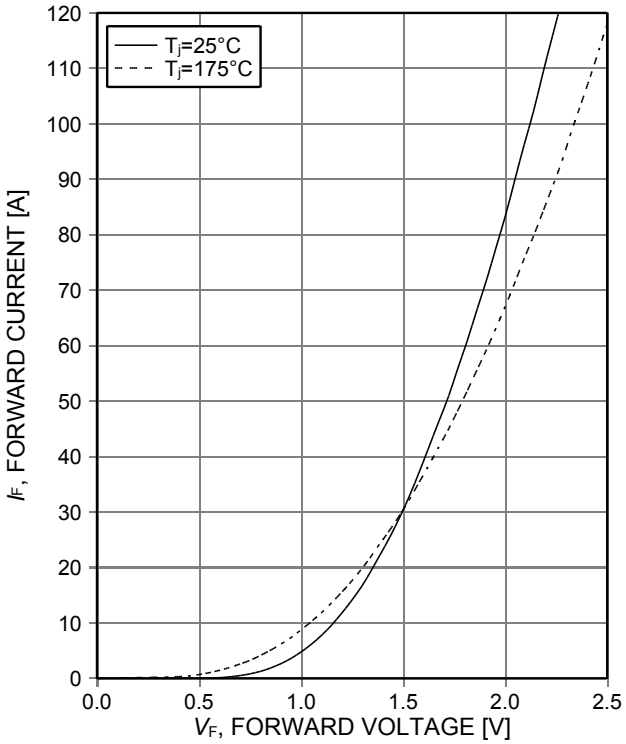


Figure 7. **Typical diode forward current as a function of forward voltage**

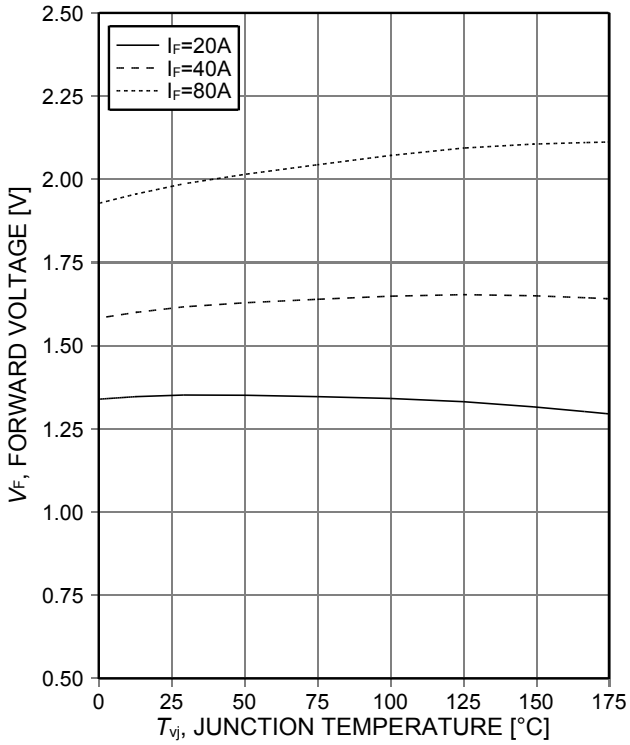
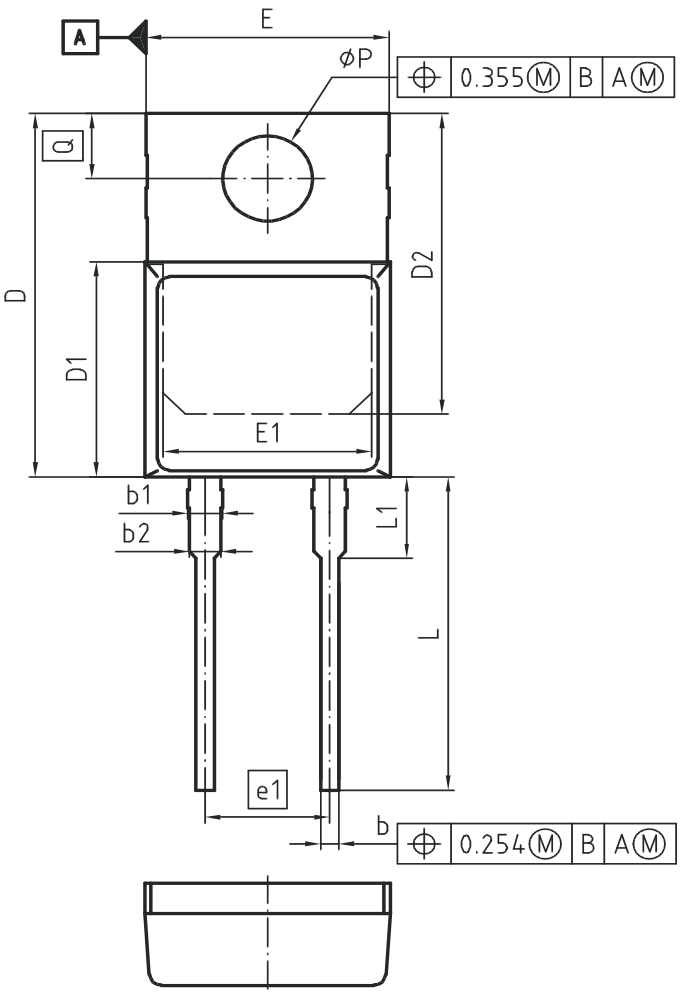


Figure 8. **Typical diode forward voltage as a function of junction temperature**

PG-TO220-2-1



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.50	0.169	0.177
A1	1.17	1.37	0.046	0.054
A2	2.30	2.50	0.091	0.098
b	0.65	0.85	0.026	0.033
b1	1.19	1.69	0.047	0.066
b2	1.19	1.39	0.047	0.055
c	0.40	0.60	0.016	0.024
D	15.35	15.95	0.604	0.628
D1	9.05	9.45	0.356	0.372
D2	12.30	13.05	0.484	0.514
E	9.80	10.20	0.386	0.402
E1	7.25	8.60	0.285	0.339
e1	5.08		0.200	
N	2		2	
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	3.30	3.70	0.130	0.146
øP	3.55	3.70	0.140	0.146
Q	2.60	3.00	0.102	0.118

DOCUMENT NO.
Z8B00150560

SCALE 0 2.5 0 2.5 5mm

EUROPEAN PROJECTION

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REVISION
01

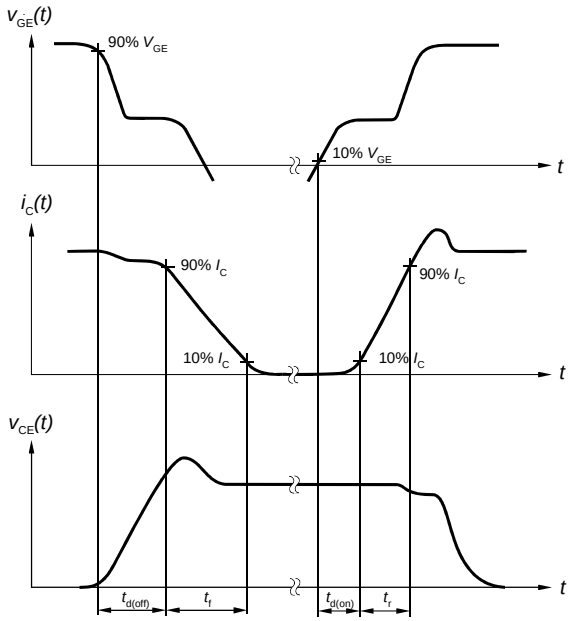


Figure A. Definition of switching times

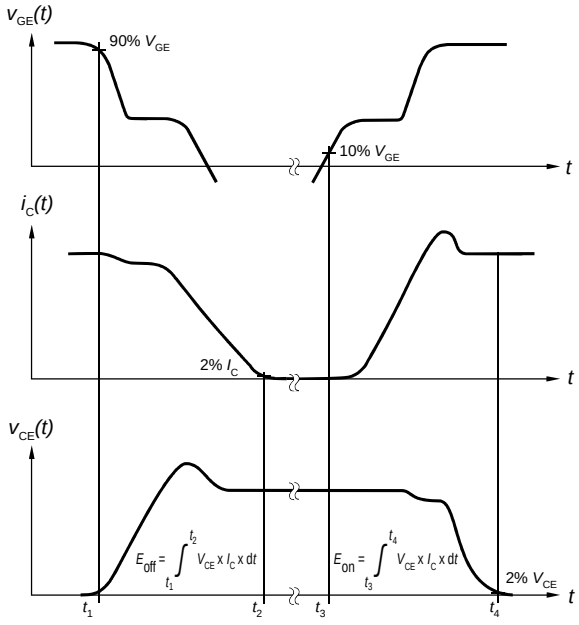


Figure B. Definition of switching losses

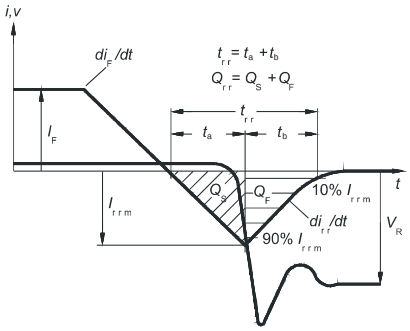


Figure C. Definition of diodes switching characteristics

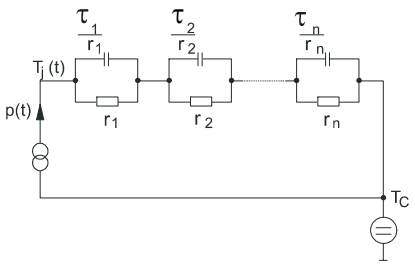


Figure D. Thermal equivalent circuit

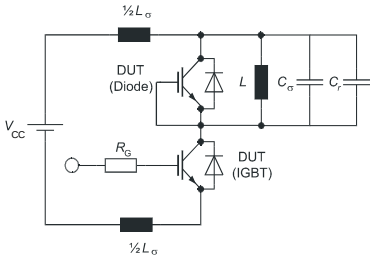


Figure E. Dynamic test circuit
Parasitic inductance L_σ,
Parasitic capacitor C_σ,
Relief capacitor C_r,
(only for ZVT switching)

Revision History

IDP40E65D2

Revision: 2014-03-31, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
1.1	2013-03-14	Preliminary data sheet
1.2	2013-03-14	-
2.1	2013-12-16	Final DS / New Marking Pattern
2.2	2014-03-31	Value VFmax limit according BE test

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